



As an inventor named below or on any attached continuation page, I hereby declare that:

My residence, post office address and citizenship are as stated next to my name.

I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled DIFFERENTIAL PRESSURE APPLICATION APPARATUS FOR USE IN POLISHING LAYERS OF SEMICONDUCTOR DEVICE STRUCTURES AND METHODS, the specification of which check 01

one):				•
□ is attached hereto. ■ was filed on July 25, 2001 as United Sta			· (P	OCT 15
	and was ame		- PATEL	
I hereby state that I have reviewed and undereferred to above.	erstand the contents of the above-identified speci	ification, including the claims, as amen	ided by any ame	Inducent WADEMA
	S. Patent and Trademark Office all information ity" is defined in Title 37, Code of Federal Reg		entability of the	subject
certificate or § 365(a) of any PCT international attached continuation page and have also identi	er Title 35, United States Code, § 119(a)-(d) or application(s) designating at least one country of fied below and on any attached continuation pagleast one country other than the United States of	other than the United States of America ge any foreign application for patent or	a listed below as inventor's certi	nd on any ficate or any
Prior foreign/PCT application(s):			Priority Claim	ed
(number)	(country)	(day/month/year filed)	Yes	No
(number)	(country)	(day/month/year filed)	Yes	No
duty to disclose to the U.S. Patent and Tradem	oplication in the manner provided by the first pa ark Office all information known to me to be ma ween the filing date of such prior application an (filing date)	aterial to patentability as defined in Tit	tle 37, Code of I	Federal
(application serial no.)	(filing date)	(status - pending, patented or	abandoned)	
I hereby claim the benefit under Title 35, U	Inited States Code, § 119(e) of any United State	s provisional application(s) listed below	v:	
(provisional application no.)	(filing date)			
I hereby appoint the following Registered P therewith:	ractitioners to prosecute this application and to t	transact all business in the Patent and T	rademark Offic	e connected
David V. Trask, Reg. No. 22,012 Joseph A. Walkowski, Reg. No. 28,765 Allen C. Turner, Reg. No. 33,041 Brick G. Power, Reg. No. 38,581 Krista Weber Powell, Reg. No. 47,867 Shawn G. Hansen, Reg. No. 42,627 Katherine A. Hamer, Reg. No. 47,628	William S. Britt, Reg. No. 20,969 James R. Duzan, Reg. No. 28,393 Edgar R. Cataxinos, Reg. No. 39,931 Paul C. Oestreich, Reg. No. 44,983 Jarett K. Abramson, Reg. No. 47,376 Bretton L. Crockett, Reg. No. 44,632 Michael L. Lynch, Reg. No. 30,871	Laurence B. Bond, Reg. No. 30, H. Dickson Burton, Reg. No. F Kent S. Burningham, Reg. No. 3 Devin R. Jensen, Reg. No. 44,80 David L. Stott, Reg. No. 43,937 Bradley B. Jensen, Reg. No. 46, Charles B. Brantley II, Reg. No.	2-48,396 30,453 05 801	
Tras P.O.	K. G. Power, telephone no. (801) 532-1922. SKBRITT, PC BOX 2550 Lake City, Utah 84110			
and further that these statements were made wi both, under Section 1001 of Title 18 of the Uni issued thereon.	rein of my own knowledge are true and that all th the knowledge that willful false statements ar ted States Code and that such willful false states	nd the like so made are punishable by fi	ine or imprison	ment, or
Full name of sole inventor: Huthan R. Brown/Inventor's signature	300 E	Date [0/3/0]		

Citizenship: U.S.A. Post Office Address: 1435 Jenna Lane, Cedar Park, TX 78613

Inventor's signature _ Residence: Cedar Park, Texas